

**II. LISTING OF THE CLAIMS:**

The present claims will replace all prior versions of claims in the present application.

1. (Previously Presented) A thermosetting resin composition comprising:

(1) a metal salt of a disubstituted phosphinic acid, and

(2) a resin having a dielectric constant of 2.9 or less at a frequency of 1 GHz or more.

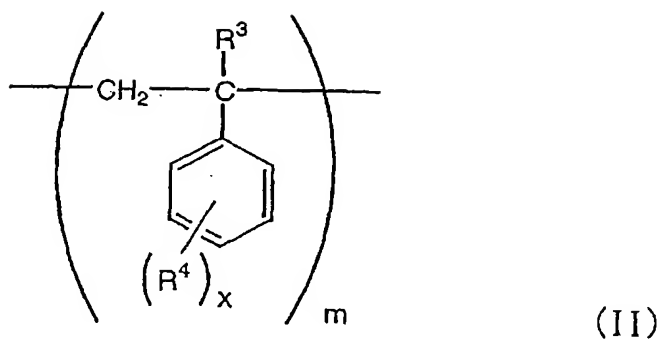
2. (Previously Presented) The thermosetting resin composition according to claim 1, wherein the dielectric constant of the thermosetting resin composition is 3.0 or less at a frequency of 1 GHz or more.

3. (Previously Presented) The thermosetting resin composition according to claim 1, which further comprises (3) a thermosetting nitrogen atom-containing resin.

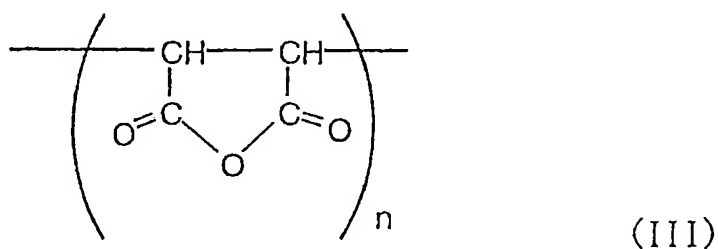
4. (Previously Presented) The thermosetting resin composition according to claim 1, wherein the component (2) is at least one resin compositions selected from the group consisting of:

copolymer resin (2-1) comprising:

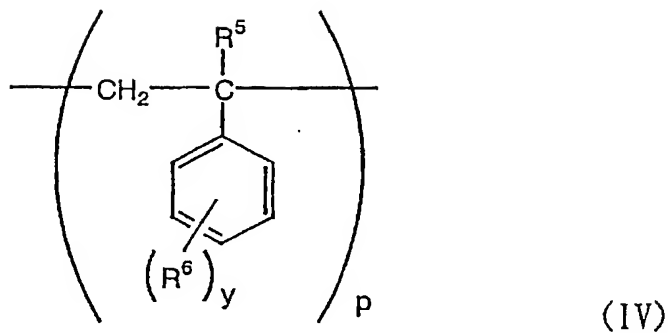
monomer unit (a) represented by formula (II):



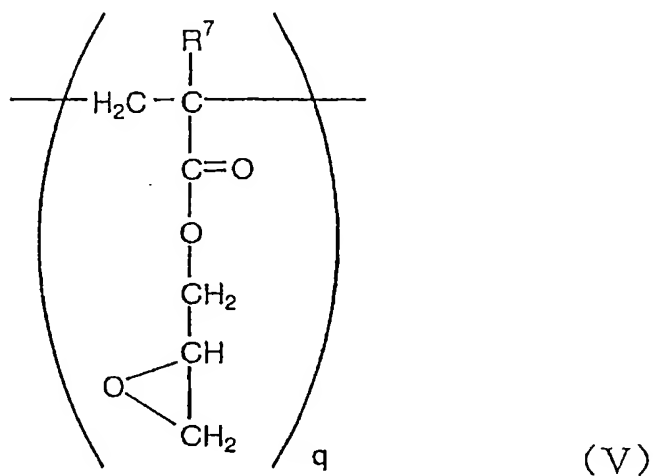
wherein  $R^3$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms;  $R^4$ 's are each independently a halogen atom, an aliphatic hydrocarbon group having 1 to 5 carbon atoms, an aromatic hydrocarbon group or a hydroxyl group;  $x$  is an integer of 0 to 3; and  $m$  is a natural number representing the repeating number of a monomer unit in a copolymer, and monomer unit (b) represented by formula (III):



wherein  $n$  is a natural number representing the repeating number of a monomer unit in a copolymer;  
copolymer resin (2-2) comprising:  
monomer unit (c) represented by formula (IV):

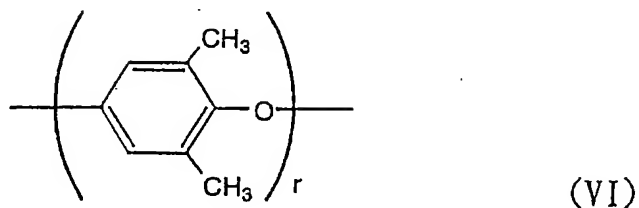


wherein  $R^5$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms;  $R^6$ s are each independently a halogen atom, an aliphatic hydrocarbon group having 1 to 5 carbon atoms, an aromatic hydrocarbon group or a hydroxyl group;  $y$  is an integer of 0 to 3; and  $p$  is a natural number representing the repeating number of a monomer unit in a copolymer, and monomer unit (d) represented by formula (V):



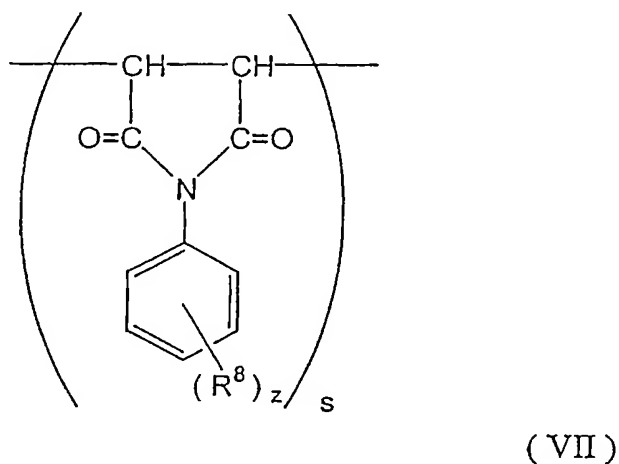
wherein  $R^7$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms; and  $q$  is a natural number representing the repeating number of a monomer unit in a copolymer; and resin (2-3) comprising:

monomer unit (e) represented by formula (VI):



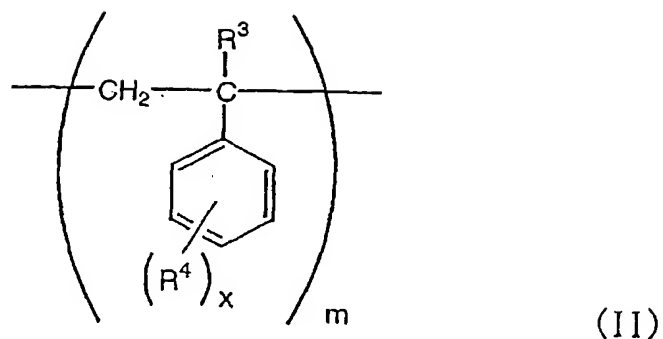
wherein  $r$  is a natural number representing the repeating number of a monomer unit in a copolymer.

5. (Previously Presented) The thermosetting resin composition according to claim 4, wherein the copolymer resin (2-1) is a copolymer resin further comprising:  
monomer unit (f) represented by the following formula (VII):

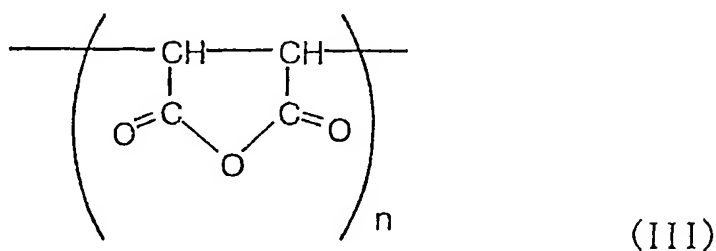


wherein  $R^8$  is a halogen atom, an aliphatic hydrocarbon group having 1 to 5 carbon atoms, an aromatic hydrocarbon group, a hydroxyl group, a thiol group or a carboxyl group;  $z$  is an integer of 0 to 3; and  $s$  is a natural number representing the repeating number of a monomer unit in a copolymer.

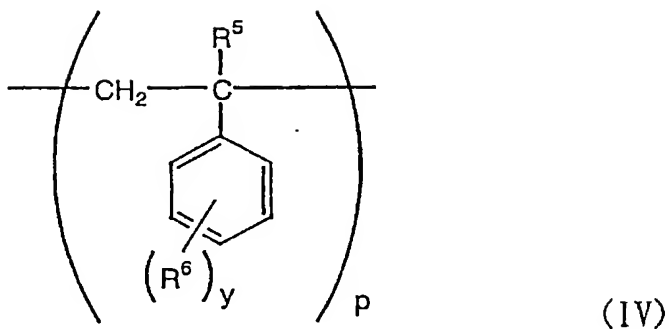
6. (Previously Presented) The thermosetting resin composition according to claim 1, which further comprises (4) an epoxy resin.
7. (Previously Presented) A prepreg using the thermosetting resin composition according to claim 1.
8. (Previously Presented) A laminated board obtained by using and laminate molding the prepreg according to claim 7.
9. (Previously Presented) A thermosetting resin composition comprising a metal salt of a disubstituted phosphinic acid, wherein a dielectric constant of the composition is 3.0 or less at a frequency of 1 GHz or more.
10. (Previously Presented) The thermosetting resin composition according to claim 2, which further comprises (3) a thermosetting nitrogen atom-containing resin.
11. (Previously Presented) The thermosetting resin composition according to claim 2, wherein the component (2) is at least one resin compositions selected from the group consisting of:  
copolymer resin (2-1) comprising:  
monomer unit (a) represented by formula (II):



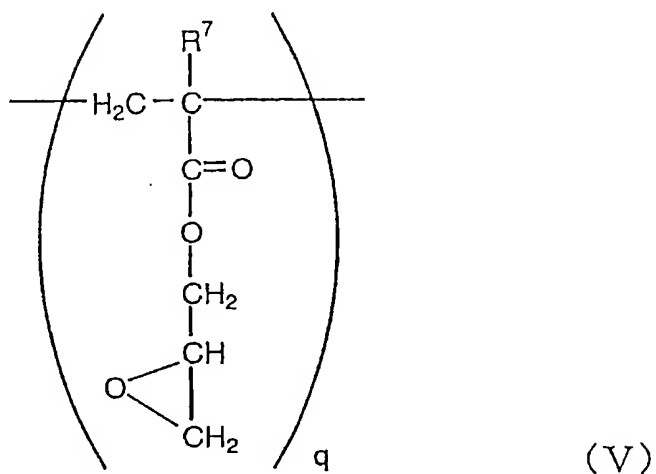
wherein  $R^3$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms;  $R^4$ 's are each independently a halogen atom, an aliphatic hydrocarbon group having 1 to 5 carbon atoms, an aromatic hydrocarbon group or a hydroxyl group;  $x$  is an integer of 0 to 3; and  $m$  is a natural number representing the repeating number of a monomer unit in a copolymer, and monomer unit (b) represented by formula (III):



wherein  $n$  is a natural number representing the repeating number of a monomer unit in a copolymer;  
copolymer resin (2-2) comprising:  
monomer unit (c) represented by formula (IV):

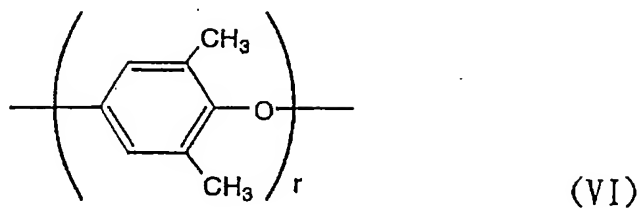


wherein  $R^5$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms;  $R^6$ s are each independently a halogen atom, an aliphatic hydrocarbon group having 1 to 5 carbon atoms, an aromatic hydrocarbon group or a hydroxyl group;  $y$  is an integer of 0 to 3; and  $p$  is a natural number and representing the repeating number of a monomer unit in a copolymer, and monomer unit (d) represented by formula (V):



wherein  $R^7$  is a hydrogen atom, a halogen atom or a hydrocarbon group having 1 to 5 carbon atoms; and  $q$  is a natural number representing the repeating number of a monomer unit in a copolymer; and resin (2-3) comprising:

monomer unit (e) represented by formula (VI):



wherein r is a natural number representing the repeating number of a monomer unit in a copolymer.

12. (Previously Presented) The thermosetting resin composition according to claim 2, which further comprises (4) an epoxy resin.